

PI6C20800

1:8 Clock Driver for Intel PCI Express® Chipsets

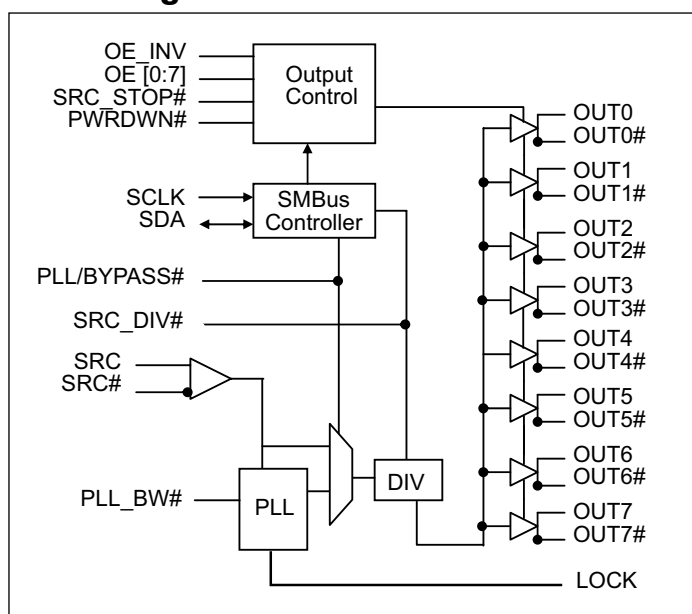
Features

- Eight Pairs of Differential Clocks
- Low skew < 50ps
- Low Cycle-to-cycle jitter < 50ps
- Output Enable for all outputs
- Outputs Tristate control via SMBus
- Power Management Control
- Programmable PLL Bandwidth
- PLL or Fanout operation
- 3.3V Operation
- 100-200 MHz PLL Mode Operation
- 100-400 MHz Bypass Mode Operation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.
- Packaging (Pb-Free & Green):
 - 48-Pin SSOP (V)

Description

PI6C20800 is a high-speed, low-noise differential clock buffer designed to be a companion to PI6C410B. The device distributes the differential SRC clock from PI6C410B to eight differential pairs of clock outputs either with or without PLL. The input SRC clock can be divided by 2 when SRC_DIV# is LOW. The clock outputs are controlled by input selection of SRC_STOP#, PWRDWN# and SMBus, SCLK and SDA. When input of either SRC_STOP# or PWRDWN# is LOW, the output clocks are Tristated. When PWRDWN# is LOW, the SDA and SCLK inputs must be Tristated.

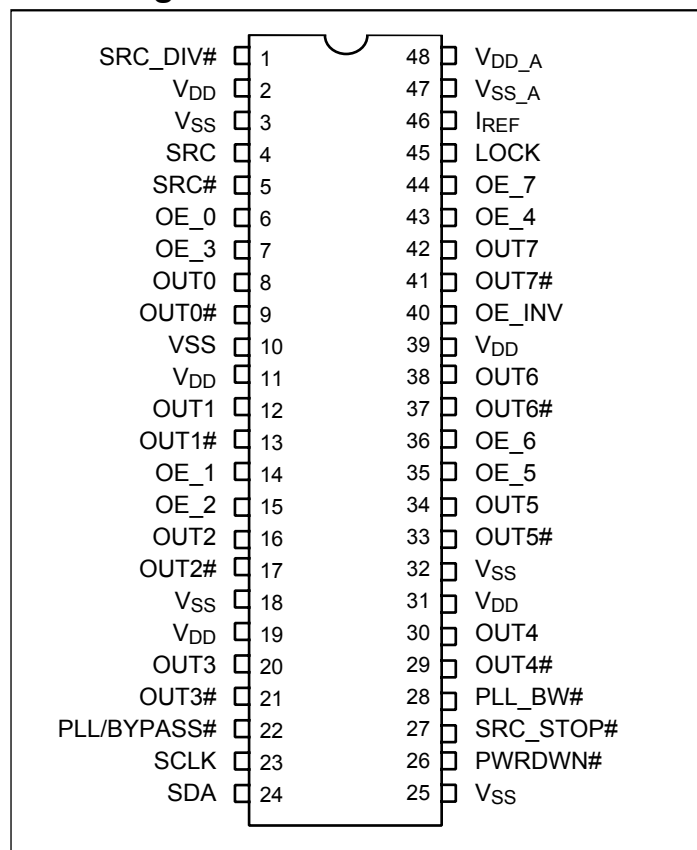
Block Diagram



Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Configuration



Pin Descriptions

Pin #	Pin Name	Type	Descriptions
1	SRC_DIV#	Input	3.3V LVTTL input for selecting input frequency divide by 2, active LOW.
4, 5	SRC & SRC#	Input	0.7V Differential SRC input from PI6C410 clock synthesizer
6, 7, 14, 15, 35, 36, 43, 44	OE [0:7]	Input	3.3V LVTTL input for enabling outputs, active HIGH.
40	OE_INV	Input	3.3V LVTTL input for inverting the OE, SRC_STOP# and PWRDWN# pins. When 0 = same stage When 1 = OE[0:7], SRC_STOP#, PWRDWN# inverted.
8, 9, 12, 13, 16 17, 20, 21, 29, 30, 33, 34, 37, 38, 41, 42	OUT[0:7] & OUT[0:7]#	Output	0.7V Differential outputs
22	PLL/BYPASS#	Input	3.3V LVTTL input for selecting fan-out of PLL operation.
23	SCLK	Input	SMBus compatible SCLOCK input
24	SDA	I/O	SMBus compatible SDATA
46	IREF	Input	External resistor connection to set the differential output current
27	SRC_STOP#	Input	3.3V LVTTL input for SRC stop, active LOW
28	PLL_BW#	Input	3.3V LVTTL input for selecting the PLL bandwidth

Pin Descriptions Cont.

Pin #	Pin Name	Type	Descriptions
26	PWRDWN#	Input	3.3V LVTTL input for Power Down operation, active LOW
45	LOCK	Output	3.3V LVTTL output, transition high when PLL lock is achieved (Latched output)
2, 11, 19, 31, 39	V _{DD}	Power	3.3V Power Supply for Outputs
3, 10, 18, 25, 32	V _{SS}	Ground	Ground for Outputs
47	V _{SS_A}	Ground	Ground for PLL
48	V _{DD_A}	Power	3.3V Power Supply for PLL

Serial Data Interface (SMBus)

This part is a slave only SMBus device that supports indexed block read and indexed block write protocol using a single 7-bit address and read/write bit as shown below.

Address assignment

A6	A5	A4	A3	A2	A1	A0	W/R
1	1	0	1	1	1	0	0/1

Data Protocol⁽¹⁾

1 bit	7 bits	1	1	8 bits	1	8 bits	1	8 bits	1	8 bits	1	1 bit
Start bit	Slave Addr	R/W	Ack	Register offset	Ack	Byte Count = N	Ack	Data Byte 0	Ack	Data Byte N - 1	Ack	Stop bit

Note:

1. Register offset for indicating the starting register for indexed block write and indexed block read. Byte Count in write mode cannot be 0.

Data Byte 0: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	SRC_DIV# 0 = Divide by 2 1 = Normal	RW	1 = x1	OUT[0:7], OUT[0:7]#	NA
1	PLL/BYPASS# 0 = Fanout 1 = PLL	RW	1 = PLL	OUT[0:7], OUT[0:7]#	NA
2	PLL Bandwidth 0 = HIGH Bandwidth, 1 = LOW Bandwidth	RW	1 = Low	OUT[0:7], OUT[0:7]#	NA
3	TBD				NA
4	TBD				NA
5	TBD				NA
6	SRC_STOP# 0 = Driven when stopped 1 = Tristate	RW	0 = Driven when stopped	OUT[0:7], OUT[0:7]#	
7	PWRDWN# 0 = Driven when stopped 1 = Tristate	RW	0 = Driven when stopped	OUT[0:7], OUT[0:7]#	NA

Data Byte 1: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	OUTPUTS enable 1 = Enabled 0 = Disabled	RW	1 = Enabled	OUT0, OUT0#	NA
1		RW	1 = Enabled	OUT1, OUT1#	NA
2		RW	1 = Enabled	OUT2, OUT2#	NA
3		RW	1 = Enabled	OUT3, OUT3#	NA
4		RW	1 = Enabled	OUT4, OUT4#	NA
5		RW	1 = Enabled	OUT5, OUT5#	NA
6		RW	1 = Enabled	OUT6, OUT6#	NA
7		RW	1 = Enabled	OUT7, OUT7#	NA

Data Byte 2: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	Allow control of OUTPUTS with assertion of SRC_STOP# 0 = Free running 1 = Stopped with SRC_Stop#	RW	0 = Free running	OUT0, OUT0#	NA
1		RW	0 = Free running	OUT1, OUT1#	NA
2		RW	0 = Free running	OUT2, OUT2#	NA
3		RW	0 = Free running	OUT3, OUT3#	NA
4		RW	0 = Free running	OUT4, OUT4#	NA
5		RW	0 = Free running	OUT5, OUT5#	NA
6		RW	0 = Free running	OUT6, OUT6#	NA
7		RW	0 = Free running	OUT7, OUT7#	NA

Data Byte 3: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	TBD	RW			
1		RW			
2		RW			
3		RW			
4		RW			
5		RW			
6		RW			
7		RW			

Data Byte 4: Pericom ID Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	Pericom ID	R	0	NA	NA
1		R	0	NA	NA
2		R	0	NA	NA
3		R	0	NA	NA
4		R	0	NA	NA
5		R	1	NA	NA
6		R	0	NA	NA
7		R	0	NA	NA

Functionality

PWRDWN#	OUT	OUT#	SRC_Stop#	OUT	OUT#
1	Normal	Normal	1	Normal	Normal
0	$I_{REF} \times 2$ or Float	LOW	0	$I_{REF} \times 6$ or Float	LOW

Power Down (PWRDWN# assertion)

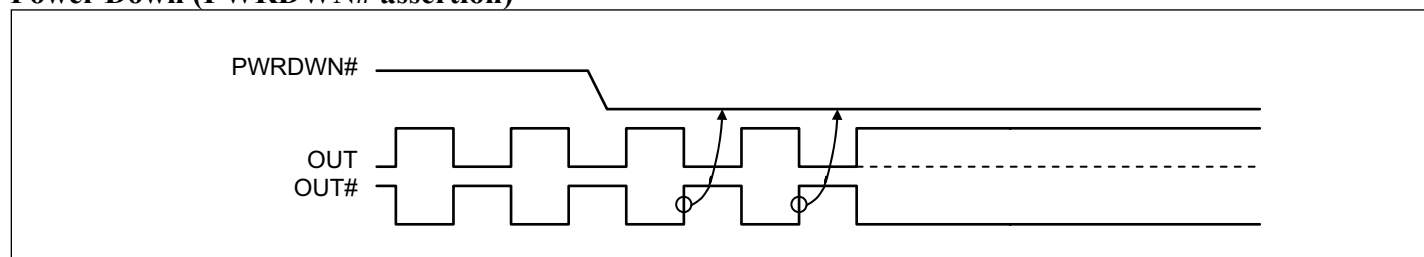


Figure 1. Power Down Sequence

Power Down (PWRDWN# De-assertion)

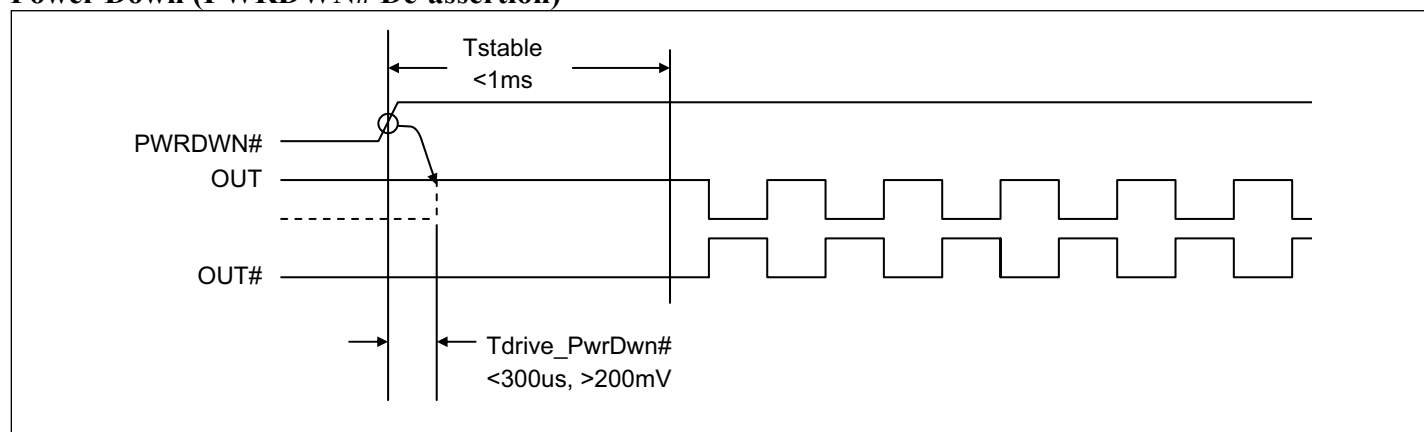


Figure 2. Power Down De-Assert Sequence

Current-Mode Output Buffer Characteristics of OUT[0:7], OUT[0:7]#

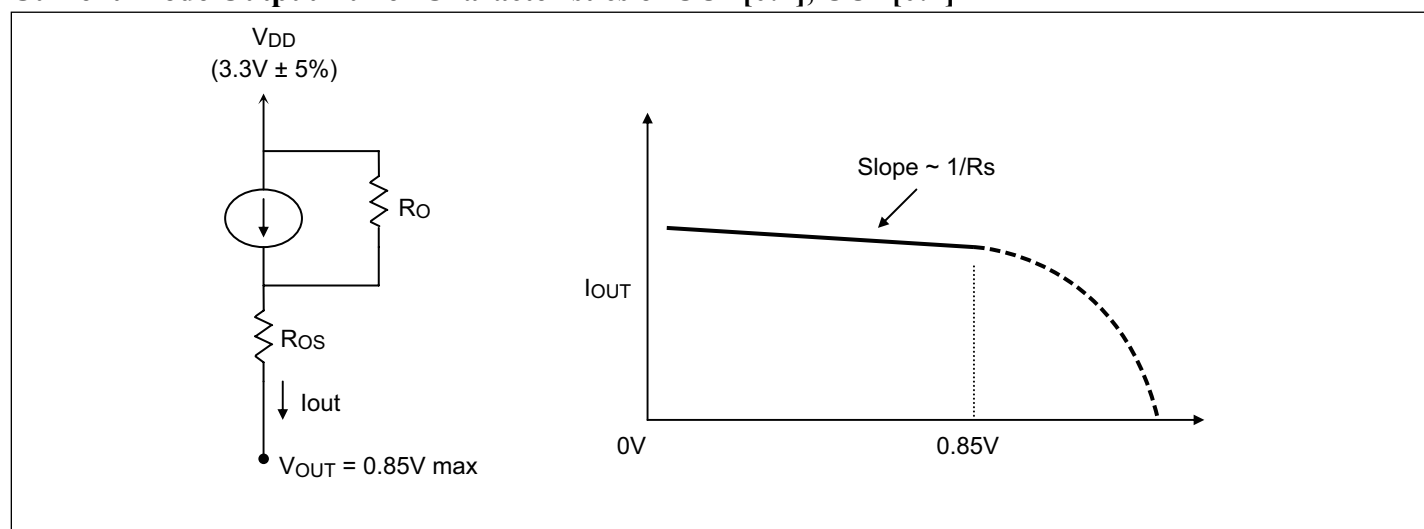


Figure 3. Simplified Diagram of Current-Mode Output Buffer

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Differential Clock Buffer characteristics

Symbol	Minimum	Maximum
R_O	3000 Ω	N/A
R_{OS}	unspecified	unspecified
V_{OUT}	N/A	850mV

Current Accuracy

Symbol	Conditions	Configuration	Load	Min.	Max.
I_{OUT}	$V_{DD} = 3.30 \pm 5\%$	$R_{REF} = 475\Omega$ 1% $I_{REF} = 2.32mA$	Nominal test load for given configuration	-12% $I_{NOMINAL}$	+12% $I_{NOMINAL}$

Note:

- $I_{NOMINAL}$ refers to the expected current based on the configuration of the device.

Differential Clock Output Current

Board Target Trace/Term Z	Reference R, $I_{ref} = V_{DD}/(3xR_r)$	Output Current	$V_{OH} @ Z$
100 Ω (100 Ω differential $\approx$ 15% coupling ratio)	$R_{REF} = 475\Omega$ 1%, $I_{REF} = 2.32mA$	$I_{OH} = 6 \times I_{REF}$	0.7V @ 50

Absolute Maximum Ratings⁽¹⁾ (Over operating free-air temperature range)

Symbol	Parameters	Min.	Max.	Units
V _{DD_A}	3.3V Core Supply Voltage	-0.5	4.6	V
V _{DD}	3.3V I/O Supply Voltage	-0.5	4.6	
V _{IH}	Input HIGH Voltage		4.6	
V _{IL}	Input LOW Voltage	-0.5		
T _s	Storage Temperature	-65	150	°C
V _{ESD}	ESD Protection	2000		V
T _J	Junction Temperature		125	°C

Note:

1. Stress beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device.

DC Electrical Characteristics (V_{DD} = 3.3±5%, V_{DD_A} = 3.3±5%)

Symbol	Parameters	Condition	Min.	Max.	Units
V _{DD_A}	3.3V Core Supply Voltage		3.135	3.465	V
V _{DD}	3.3V I/O Supply Voltage		3.135	3.465	
V _{IH}	3.3V Input HIGH Voltage	V _{DD}	2.0	V _{DD} + 0.3	
V _{IL}	3.3V Input LOW Voltage		V _{SS} – 0.3	0.8	
I _{IK}	Input Leakage Current	0 < V _{IN} < V _{DD}	-5	+5	μA
V _{OH}	3.3V Output HIGH Voltage	I _{OH} = -1mA	2.4		V
V _{OL}	3.3V Output LOW Voltage	I _{OL} = 1mA		0.4	
I _{OH}	Output HIGH Current	I _{OH} = 6 x I _{REF} , I _{REF} = 2.32mA	12.2	15.6	mA
C _{IN}	Logic Input Pin Capacitance		1.5	5	
C _{OUT}	Output Pin Capacitance			6	pF
L _{PIN}	Pin Inductance			7	nH
I _{DD}	Power Supply Current	V _{DD} = 3.465V, F _{CPU} = 200MHz		250	mA
I _{SS}	Power Down Current	Driven outputs		60	
I _{SS}	Power Down Current	Tristate outputs		12	
T _A	Ambient Temperature		0	70	°C

PI6C20800
AC Switching Characteristics^(1,2,3) ($V_{DD} = 3.3 \pm 5\%$, $V_{DD_A} = 3.3 \pm 5\%$)

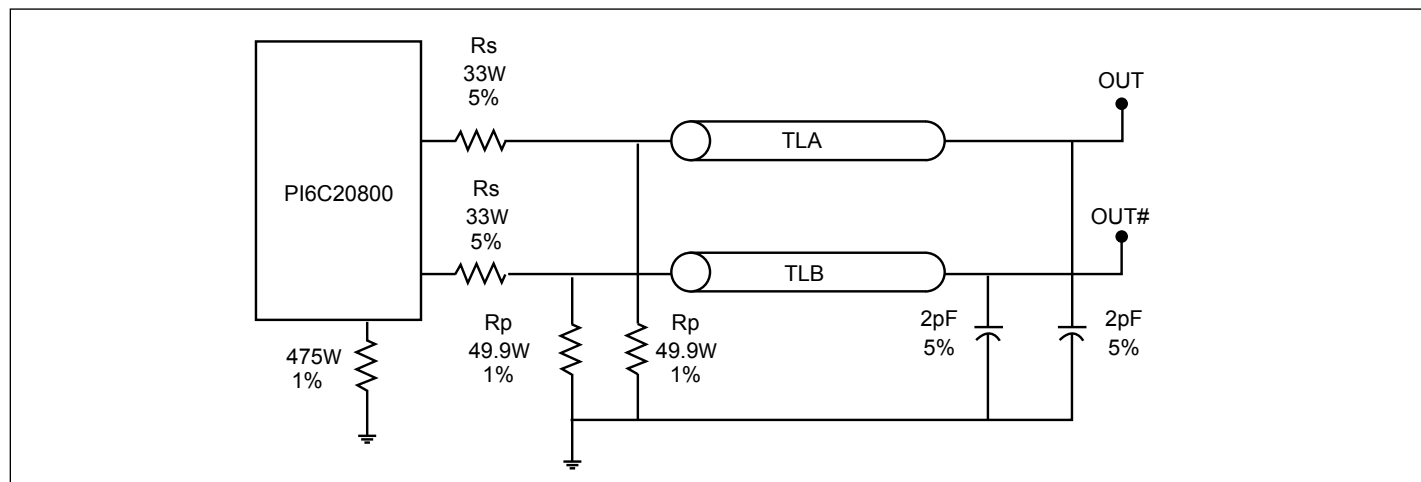
Symbol	Parameters	Min	Max.	Units	Notes
F _{IN}	PLL Mode	100	200	MHz	
	Bypass Mode	100	400	MHz	
T _{rise} / T _{fall}	Rise and Fall Time (measured between 0.175V to 0.525V)	175	700	ps	2
$\Delta T_{rise} / \Delta T_{fall}$	Rise and Fall Time Variation		125		2
T _{skew}	Output-to-Output Skew		50	ps	3
V _{HIGH}	Voltage HIGH	660	850	mV	2
V _{OVS}	Max. Voltage		1150		
V _{UDS}	Min. Voltage	-300			
V _{LOW}	Voltage LOW	-150	+150		2
V _{cross}	Absolute crossing poing voltages	250	550		2
ΔV_{cross}	Total Variation of V _{cross} over all edges		140		2
T _{DC}	Duty Cycle	45	55	%	3
T _{jyc-cyc}	Jitter, Cycle-to-cycle (PLL Mode, Measurement for differential waveform)		50	ps	
	Jitter, Cycle-to-cycle (BYPASS mode as additive jitter)				

Notes:

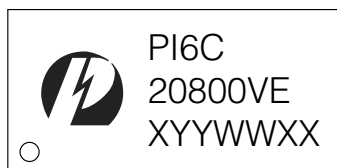
1. Test configuration is R_S = 33.2Ω, R_p = 49.9Ω, and 2pF.
2. Measurement taken from Single Ended waveform.
3. Measurement taken from Differential waveform.

PI6C20800

Configuration Test Load Board Termination



Part Marking



X: Die Rev

YY: Year

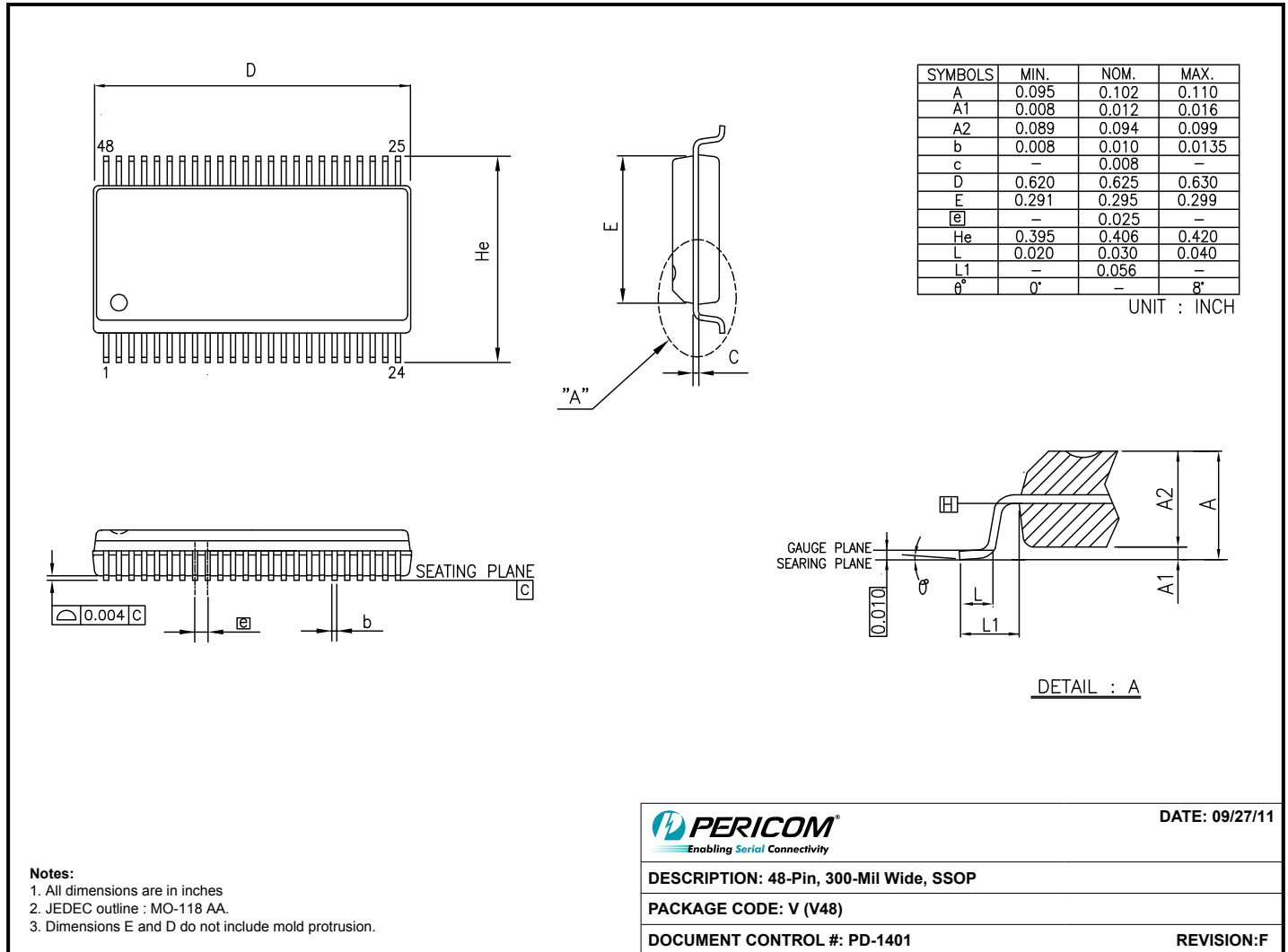
WW: Workweek

1st X: Assembly Code

2nd X: Fab Code

PI6C20800

Packaging Mechanical: 48-SSOP (V)



11-0197

For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

Ordering Information

Ordering Code	Package Code	Package Description
PI6C20800VEX	V	48-pin, 300-mil wide (SSOP)

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. E = Pb-free and Green
5. X suffix = Tape/Reel

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